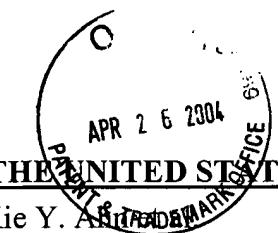


S/N 09/483,881



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. An
Serial No.: 09/483,881
Filed: January 18, 2000
Title: SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

Examiner: Ha Nguyen

Group Art Unit: 2812

Docket No.: 303.672US1

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This paper responds to the Office Action mailed on December 23, 2003. Please amend the above-identified patent application as follows.